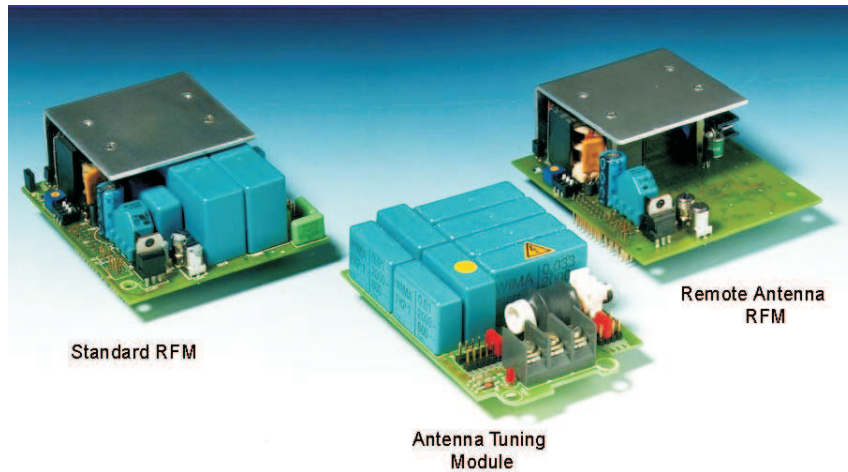


HIGH PERFORMANCE LF RADIO FREQUENCY MODULE

FEATURES

- **Common**
 - Variable Power Supply Range
 - Synchronization Control in Multi-Reader Arrays
 - High Power Output
- **Standard RFM**
 - Capacitive Tuning to Resonance
- Supports Antenna Cable Lengths Up to 10 Meters (Depending on Antenna Design)
- **Remote Antenna RFM**
 - Supports Antenna Cable Lengths Up to 120 Meters
 - Capacitive and Inductive Tuning to Resonance



DESCRIPTION

The RI-RFM-007B radio frequency power module is capable driving a variety of antennas with inductance ranges from 26.0 μ H to 27.9 μ H including TI standard antennas RI-ANT-G01E, RI-ANT-G02E, RI-ANT-G04E gate antennas as well as RI-ANT-S01C and RI-ANT-S02C stick antennas.

The RI-RFM-007B module in combination with a control module is well suited for usage in a broad range of applications including, but not limited to, access control, vehicle identification, container tracking, asset management and waste management applications.

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

	RI-RFM-007B	RI-RFM-008B	RI-ACC-008B	UNIT
Operating Temperature	–25 to +70	–25 to +70	–25 to +70	°C
Storage Temperature	–40 to +85	–40 to +85	–40 to +85	°C

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

RECOMMENDED OPERATING CONDITIONS

over operating free-air temperature range (unless otherwise noted)

	RI-RFM-007B	RI-RFM-008B	RI-ACC-008B
Power Supply	7 to 24 Vdc regulated If switched Power Supply is used, the frequency must be > 200 kHz		

OPERATING CHARACTERISTICS

over operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS			UNIT
	RI-RFM-007B (STANDARD RFM)	RI-RFM-008B (REMOTE ANTENNA RFM)	RI-ACC-008B (ANTENNA TUNING MODULE)	
Relative Humidity	Acc. to IEC 68-2-30 >= 93% non condensing, Test Db, 21 cycles			
RF Transmit Power	To be set by pulse width to comply with PTT/FCC regulations			
RF Transmit Frequency	134.2 kHz			
Antenna Resonance Voltage	max. 380 Vpeak	max. 380 Vpeak	max. 380 Vpeak If used with customer designed antenna, it may be necessary to limit the output to 280 Vpeak	
Antenna Tuning Range	26 to 27.9	26 to 27.9	8 to 80 (including cable)	μH
Dimensions (L × W × H)	83 × 93 × 44 ± 1.5	83 × 93 × 44 ± 1.5	115 × 70 × 27 ± 1.5	mm
Weight	± 260	± 160	± 162	g
RECOMMENDED ACCESSORIES				
Antenna Tuning Module	No	RI-ACC-008B	No	
Digital Reader Module	RI-CTL-010A	RI-CTL-010A	No	

Additional specifications and application conditions are defined in the relevant RFM Reference Manual (11-06-21-042 (SCBU022) & 11-06-21-033) available on internet at: <http://www.ti.com/mc/docs/tiris/docs/specs/htm>.

Texas Instruments reserves the right to change its products and services at any time without notice. TI provides customer assistance in various technical areas, but does not have full access to data concerning the uses and applications of customer's products. Therefore, TI assumes no responsibility for customer product design or for infringement of patents and/or the rights of third parties, which may result from assistance provided by TI.

For more information call the Sales or Application Center nearest you, or view our internet home page:
(<http://www.ti.com/mc/docs/tiris>).

Europe

France: Phone: 33 1 30 70-1065
Fax: 33 1 30 70-1054

Germany:Phone: 49 816 180 4014
Fax: 49 816 180 4918

Holland: Phone: 31 546 879555
Fax: 31 546 870535

Italy: Phone: 39 39 6842-318
Fax: 39 39 6842-316

UK: Phone: 44 1604 663070
Fax: 44 1604 663099

North & South America

USA: Phone: 1 214-917-1462
Fax: 1 214-917-1440

Canada: Phone: 1 416-884-9181
Fax: 1 416-884-7739

Brazil: Phone: 55 11 5506 5133
Fax: 55 11 5506 0544

Asia

Australia:Phone: 61 3 9696-1211
Fax: 61 3 9696-4446

Japan: Phone: 81 3-3498-2195
Fax: 81 3-3498-5266

Korea: Phone: 82 2 551 2934
Fax: 88 2 551 3211

Singapore:Phone: 65 833 6000
Fax: 65 833 6063

Taiwan: Phone: 886 2 376 2571
Fax: 886 2 377-2717

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
RI-ACC-008B-30	ACTIVE			0	1	TBD	Call TI	Call TI
RI-RFM-007B-00	OBSOLETE			1		TBD	Call TI	Call TI
RI-RFM-007B-30	ACTIVE			0	1	TBD	Call TI	Call TI
RI-RFM-008B-30	ACTIVE			0	1	TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer:The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products

Amplifiers	amplifier.ti.com
Data Converters	dataconverter.ti.com
DLP® Products	www.dlp.com
DSP	dsp.ti.com
Clocks and Timers	www.ti.com/clocks
Interface	interface.ti.com
Logic	logic.ti.com
Power Mgmt	power.ti.com
Microcontrollers	microcontroller.ti.com
RFID	www.ti-rfid.com
RF/IF and ZigBee® Solutions	www.ti.com/lprf

Applications

Audio	www.ti.com/audio
Automotive	www.ti.com/automotive
Broadband	www.ti.com/broadband
Digital Control	www.ti.com/digitalcontrol
Medical	www.ti.com/medical
Military	www.ti.com/military
Optical Networking	www.ti.com/opticalnetwork
Security	www.ti.com/security
Telephony	www.ti.com/telephony
Video & Imaging	www.ti.com/video
Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2009, Texas Instruments Incorporated

www.BDTIC.com/TI